ASSOCIATION CONNECTING LECTRONICS INDUSTRIES INDUSTRIES	annockburn, Illinois. A	ll rights reserved un ntions.	ider both Iev	is docume vel parts, th	ent is a declaration en	n of the substance compasses all low	es within the manufactur ver level materials for wl	er listed item hich the manu	Note: if the second sec	he item is an as as engineering	sembly with lower responsibility.
	IPC Web Site for Information on IPC-1752 Standard Form T http://www.ipc.org/IPC-175x Distribution			* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information					1		
Supplier Information											
Company name*	que ID		Unique ID Authority			Response Date*					
ısemi								2025-06-06			
Contact Name	Name Title - Contact			Phone - Contact*				Email - Contact*			
roduct-Env-Stewards Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Representative				Phone - Representative*				Email - Representative*			
Product-Env-Stewards Product Enviro Cor			Compliance		NA			Product-Env-Stewards@onsemi.com			
Requester Item Number N	Ifr Item Number	Mfr Item Name			Effective Date	Version	Manufacturing Site		ght*	UOM	Unit Type
N	ICP3064BMNTXG	P3064BMNTXG 1.5A SW REG WI			2025-06-06 MY1		40.0		mg	Each	
Manufacturing Proccess Information						·		i		·	
Terminal Plating / Grid Array Material	Terminal Base	Alloy J-	STD-020 MSL Ra	D-020 MSL Rating		Peak Process Body Temperature Max Time at F		k Temperature Number of Reflow Cycles			
Matte Tin (Sn) - annealed CU Alloy 1					260	С	30	seconds	3		
Comments											
level 1 - maximum time at peak temperature du	ring soldering is 10-3	0 seconds									
For more information regarding material comp	osition please refer to	page 3									

RoHS Material Composition Declaration				Declaration Type *	Detailed				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).								
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of				
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted				
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all				
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the				
Supplier Digital Signature Ra	stislav Drska	Le							

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.4	mg	Supplier	Silicon (Si)	7440-21-3		0.4	mg
Die Attach	0.95	mg	Supplier	Silver (Ag)	7440-22-4		0.7125	mg
			Supplier	Epoxy resins	129915-35-1		0.2375	mg
Lead Frame 14.	14.94	mg	Supplier	Silver (Ag)	7440-22-4		2.9282	mg
			Supplier	Iron (Fe)	7439-89-6		0.1195	mg
			Supplier	Copper (Cu)	7440-50-8		11.8922	mg
Mold Compound-Black	20.0	mg		Epoxy resin	proprietary data		1.4	mg
			Supplier	Phenolic Resin	Proprietary Data		1.4	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		3	mg
			Supplier	Carbon Black (C)	1333-86-4		0.1	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		14.1	mg
Plating	1.11	mg	Supplier	Tin (Sn)	7440-31-5		1.11	mg
Wire Bond - Au	2.6	mg	Supplier	Gold (Au)	7440-57-5		2.6	mg